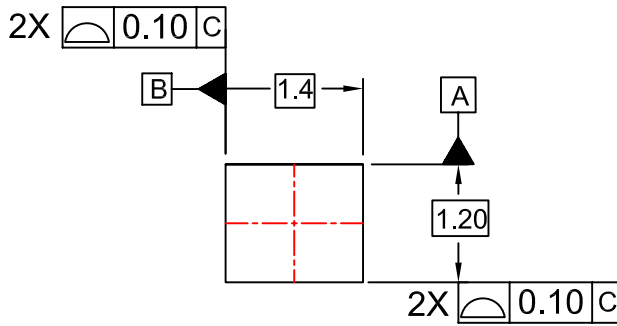
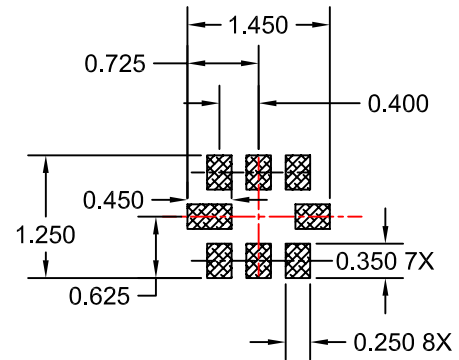


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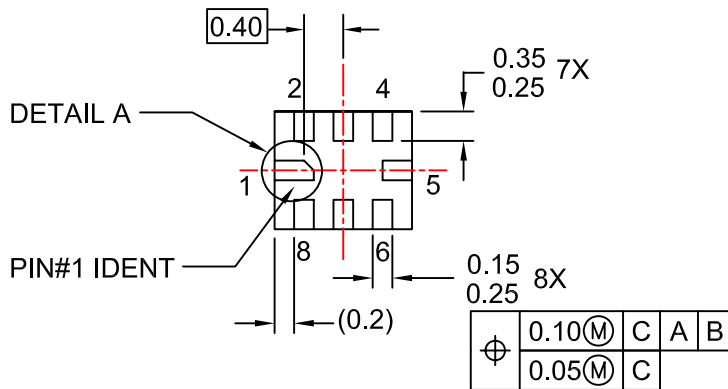
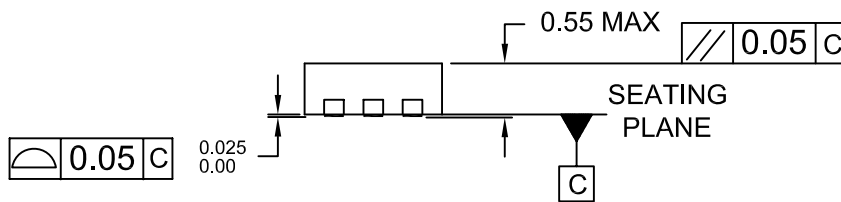
REVISIONS				
LTR	DESCRIPTION	EDCN	DATE	BY/APP'D
1	RELEASE TO DOCUMENT CONTROL	MKT-UMLP08A	01-11-08	Carrie Chew



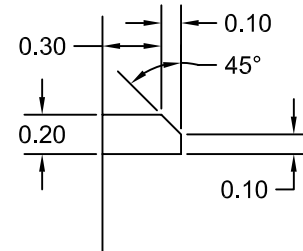
TOP VIEW



LAND PATTERN RECOMENDATION



BOTTOM VIEW



DETAIL: A
SCALE : 2x

NOTES:

- A. DOES NOT CONFORMS TO JEDEC STANDARD.
- B. DIMENSIONS ARE IN MILLIMETERS.
- C. DIMENSIONS AND TOLERANCES CONFORMS TO ASME Y14.5M, 1994.
- D. DRAWING FILE NAME : UMLP08AREV1

APPROVALS	DATE	FAIRCHILD SEMICONDUCTOR®			
DRAWN David Chong	03 Jan 08	Bayan Lepas, FIZ, 11900, Penang, Malaysia.			
DFTG. CHK. J Chan	09 Jan 08	8LD, uMLP, 1.4x1.2 MM 0.40 MM Pitch			
ENGR. CHK. Stephen Martin	10 Jan 08				
		SCALE N/A	SIZE N/A	DRAWING NUMBER MKT-UMLP08A	REV 1
DO NOT SCALE DRAWING			SHEET 1 of 1		